1.0 Scope
The purpose of this test method is to provide a consistent procedure to test the sensitivity of electronic components to ultrasonic energy. There has been a reluctance in the electronics industry to use ultrasonic energy for printed board assemblies cleaning because of the possibility of damage to wire bonds in active, hermetically sealed components or other damage that might cause latent failures.

Recent work has shown that electronic components have a low potential for damage from ultrasonics (See 6.1) under conditions seen in most cleaning processes. In addition, MIL-STD-2000 Rev. A and J-STD 001 now allow for the use of ultrasonic cleaning, as does the proposal for IEC TC91 International Standards based on an updated revision of the J-STD-001.

1.1 Definitions
Ultrasound: All sound in frequencies above the range of human hearing. For the purpose of ultrasonic cleaning, frequencies between 18-800 kHz are in commercial use. In the lower frequency ranges, fluid cavitation is the primary agitation method. In the higher frequency ranges, microstreaming (i.e., fluid pumping) is believed to be the form of mechanical agitation.

Frequency: The number of periodic oscillations, vibrations of waves per unit of time, usually expressed in cycles per second.

Generator: An electronic system which converts the 50 or 60 Hz power line electricity into an ultrasonic frequency drive signal which powers the transducers in their resonant frequency range.

Transducers: Convert electrical energy from the generator into mechanical (vibratory) energy, producing high intensity sound waves in a liquid and causing cavitation. Transducers are primarily of two types.

Piezoelectric: Piezoelectric ceramics, which change dimensions in the presence of an electric field. Thickness varies in response to an applied voltage. Conversion efficiency = 70-90%

Magnetostriuctive: Made of nickel or its alloys, it changes length when placed in a magnetic field. Conversion efficiency = 20-50%

Cavitation: The rapid formation and oscillation or violent collapse of microscopic bubbles or cavities in a liquid, produced by introducing high frequency (ultrasonic) sound waves into a liquid. The agitation from countless implosions of these bubbles create a highly effective scrubbing of both exposed and hidden surfaces of parts immersed in the cleaning solution.

Degas: The act of removing entrained gas from cleaning fluid. Gas bubbles tend to absorb ultrasonic energy, thereby decreasing the amount of energy available for cleaning.

2.0 Applicable Documents
2.1 Institute for Interconnecting and Packaging Electronic Circuits (IPC)
IPC-T-50 Terms and Definitions for Interconnecting and Packaging Electronic Assemblies
IPC-CH-65 Guidelines for Cleaning of Printed Boards and Assemblies

2.2 Joint Industry Standards
J-STD-001 Requirements for Soldered Electrical and Electronic Assemblies

2.3 Military MIL-STD-2000 Rev. A Standard Requirements for Soldered Electrical and Electronic Assemblies

2.4 Other Publications
IEC-TC-91 Proposed International Standard (based on J-STD-001) International Requirements for Soldered Electrical and Electronic Assemblies Using Surface Mount and Related Assembly Technologies

3.0 Test Specimens
The board mounted components to be tested should be the exact type and configuration the tester intends to use in production. A statistically valid number of each type and package style of component of interest should be tested. For example, if actual production boards are used for testing and only one of a particular component is contained on the board, then a statistically valid number of boards will have to be tested. If, instead of production boards, dummy boards are used, they
should be of the same general size and construction as production boards. A minimum of five boards shall be run.

4.0 Apparatus

4.1 Tank
Testing shall be done in an ultrasonic tank, preferably in the equipment to be used in production. Water is to be used as the ultrasonic transmission testing fluid, regardless of the cleaning agent to be used in the production process. Water will degas, transmit ultrasonics, and cavitate more easily than most new cleaning agents and is, therefore, considered a “worst case” ultrasonic testing fluid. Care must be taken to maintain water level during testing. Water temperatures should be maintained at 60°C ±5°C (140°F ±10°F).

It is recommended that testing equipment operate near 40 KHz or higher and have a power output in the range listed in the chart below. Power is measured as the output from the generator to the transducers. Note in the chart that the amount of power necessary is scaled for various tank sizes.

If power densities or frequencies differing from the ranges listed above are to be used in production, they should be used in testing as well, and noted on the Ultrasonic Test Data Record.

<table>
<thead>
<tr>
<th>Tank Size liters (gallons)</th>
<th>Power Density watts/liter(watts/gallon)</th>
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<tbody>
<tr>
<td></td>
<td>Magnetostrictive</td>
</tr>
<tr>
<td>19 (5)</td>
<td>66-76 (250-290)</td>
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<tr>
<td>38 (10)</td>
<td>53-58 (200-220)</td>
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<tr>
<td>95 and greater (25 and greater)</td>
<td>21-32 (80-120)</td>
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5.0 Procedure and Evaluation

Note: Standard ESD handling methods should be used in handling and assembly so as not to have ESD damage misinterpreted as damage by ultrasonic exposure.

5.1 Procedure

5.1.1 Solder components into (onto) a test circuit board. Perform functional electrical tests on components to be subjected to ultrasonic energy. It is suggested that all components go through standard prescreening tests to eliminate infant mortality. Note any anomalies and ignore any malfunctions in further testing.

5.1.2 Visually inspect the solder joints of SMD leads at 10-15x for conformance with J-STD-001. Document any observed defects with notes or photos.

5.1.3 Fill the test tank with deionized water. Turn on ultrasonics and allow a minimum of 15 minutes for the water to degas. Evidence of cavitation should be obtained by placing a piece of aluminum foil in the water for one minute and inspecting for an erosion pattern (evidence of cavitation activity). If the surface of the foil is not disrupted, continue to degas until the foil confirms ultrasonic activity.

Test components in the equipment described above. Boards should be placed in the tank in the same quantity and orientation as will be the case in production, taking into consideration the size of the test tank in relation to the production unit. Boards should be positioned perpendicular to the radiating surface (tank surface where transducers are mounted) and should not be allowed to rest on the radiating surface (Figure 1).

Subject specimens to ultrasonics for a time period 10 times longer than the expected exposure anticipated under normal cleaning conditions or thirty minutes, whichever is longer.

5.1.3 (Optional) Conduct any environmental stressing test(s) as specified by the reliability requirement of the product line in concern.

5.2 Evaluation Method

5.2.1 Repeat the functional electrical test in 5.1.1. Any failures should be analyzed for cause of failure. Any failure, excluding those noted in 5.1.1 or attributable to a documented defect, will be considered caused by the ultrasonics.

5.2.2 Repeat the visual inspections as described in 5.1.2. Any defect which is not assignable to a previously documented defect will also be considered caused by ultrasonics.

5.2.3 Any component exhibiting no failures or 100% reliability after ultrasonic testing will be considered safely resistant to ultrasonics under the conditions tested. Any component with less than 100% reliability will be suspect unless subsequent testing can demonstrate that it is 100% reliable. Unless classified or proprietary, please report test results to the Ultrasonic Cleaning Task Group of the IPC for compilation in the attached list.
Note: It is important that the IPC receives as much data as possible, whether it be to support previously submitted data, add new data, or provide conflicting data on certain components. All information received will be entered into a database for all IPC members to access. The database will prove more useful as the volume of data increases.

6.0 Notes
Contact IPC for a list of tested components.

6.1 References


Figure 1

U/S = ULTRASONIC ENERGY (TRANSDUCERS)
# Ultrasonic Test Data Record

Name of tester ___________________________ Date ______________

Company ____________________________________________

Address ____________________________________________

Phone __________________ Fax __________________

Make and model of equipment ____________________________

Tank size __________________ Dimensions (cm cm x cm) __________

Generator output power __________________ Frequency (KHz) __________

No. of boards tested per trial __________________ Substrate __________

Exposure time _______________________________________

Other stress testing (pre- or post-) ______________________

Describe ____________________________________________

<table>
<thead>
<tr>
<th>Component tested</th>
<th>No. tested</th>
<th>Passed</th>
<th>Failed</th>
<th>Comments</th>
</tr>
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<tbody>
<tr>
<td>Type</td>
<td>Mfr</td>
<td>Part #</td>
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Mail to: IPC
2215 Sanders Road
Northbrook, IL 60062-6135
Attn: Ultrasonic Cleaning Task Group

Fax to: 847-509-9798